TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74VHCT32AF, TC74VHCT32AFT, TC74VHCT32AFK

#### Quad 2-Input OR Gate

The TC74VHCT32A is an advanced high speed CMOS 2-INPUT OR GATE fabricated with silicon gate  $C^2MOS$  technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The internal circuit is composed of 4 stages including buffer output, which provide high noise immunity and stable output.

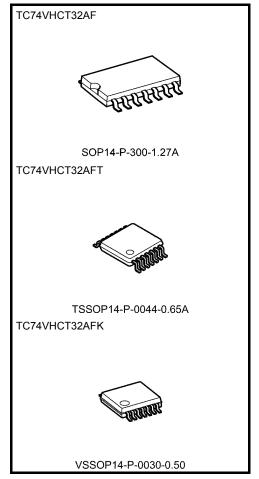
The input voltage are compatible with TTL output voltage. This device may be used as a level converter for interfacing  $3.3\ V$  to  $5\ V$  system.

Input protection and output circuit ensure that 0 to 5.5 V can be applied to the input and output  $^{\rm (Note)}$  pins without regard to the supply voltage. These structure prevents device destruction due to mismatched supply and input/output voltages such as battery back up, hot board insertion, etc.

Note:  $V_{CC} = 0 V$ 

#### **Features**

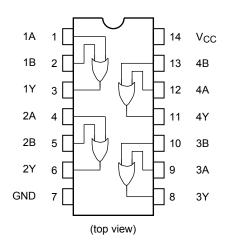
- High speed:  $t_{pd} = 3.8 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 2 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- Compatible with TTL inputs:  $V_{IL} = 0.8 \text{ V (max)}$  $V_{IH} = 2.0 \text{ V (min)}$
- Power down protection is provided on all inputs and outputs.
- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Low noise: VOLP = 0.8 V (max)
- Pin and function compatible with the 74 series (74AC/HC/F/ALS/LS etc.) 32 type.



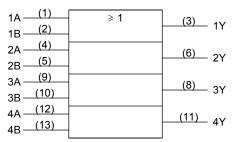
Weight

SOP14-P-300-1.27A: 0.18 g (typ.) TSSOP14-P-0044-0.65A: 0.06 g (typ.) VSSOP14-P-0030-0.50: 0.02 g (typ.)

#### **Pin Assignment**



### **IEC Logic Symbol**



#### **Truth Table**

Α	В	Υ
Н	Н	Н
L	Н	Н
Н	L	Н
L	L	L

### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit	
Supply voltage range	V <sub>CC</sub>	−0.5 to 7.0	V	
DC input voltage	V <sub>IN</sub>	−0.5 to 7.0	V	
DC output voltage	V	-0.5 to 7.0 (Note 2)	V	
	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5 (Note 3)	V	
Input diode current	lıĸ	-20	mA	
Output diode current	lok	±20 (Note 4)	mA	
DC output current	lout	±25	mA	
DC V <sub>CC</sub> /ground current	Icc	±50	mA	
Power dissipation	PD	180	mW	
Storage temperature	T <sub>stg</sub>	−65 to 150	°C	

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2:  $V_{CC} = 0 V$ 

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: Vout < GND, Vout > Vcc



# **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	4.5 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	V <sub>OUT</sub>	0 to 5.5 (Note 2)	٧	
		0 to V <sub>CC</sub> (Note 3)	V	
Operating temperature	T <sub>opr</sub>	−40 to 85	°C	
Input rise and fall time	dt/dV	0 to 20	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either  $V_{\mbox{\footnotesize CC}}$  or GND.

Note 2:  $V_{CC} = 0 V$ 

Note 3: High or low state

#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics Symbol	Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit	
, , , , , , , , , , , , , , , , , , , ,				V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
High-level input voltage	V <sub>IH</sub>	_		4.5 to 5.5	2.0	_	ı	2.0	_	٧
Low-level input voltage	V <sub>IL</sub>	_		4.5 to 5.5	_	_	0.8	_	0.8	٧
High-level output		V <sub>IN</sub>	I <sub>OH</sub> = -50 μA	4.5	4.40	4.50	-	4.40	_	V
voltage		= V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = −8 mA	4.5	3.94	_	1	3.80	_	
Low-level output	Voi	V <sub>IN</sub>	I <sub>OL</sub> = 50 μA	4.5	l	0.0	0.1	1	0.1	V
voltage	VOL	= V <sub>IL</sub>	I <sub>OL</sub> = 8 mA	4.5	ı	_	0.36	1	0.44	٧
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	ı	_	±0.1	ı	±1.0	μΑ
0.4	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	ı	_	2.0	1	20.0	μΑ
Quiescent supply current ICC	Ісст	Per input: V <sub>IN</sub> = 3.4 V Other input: V <sub>CC</sub> or GND		5.5	_	_	1.35	_	1.50	mA
Output leakage current	I <sub>OPD</sub>	V <sub>OUT</sub> = 5.5 V		0		_	0.5	_	5.0	μA

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### AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics Sym	Symbol	Test Condition			Ta = 25°C			Ta = −40 to 85°C		Unit
	-,		V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Min	Max	
Propagation delay	t <sub>pLH</sub>		5.0 ± 0.5	15	_	3.8	5.5	1.0	6.5	6.5 8.5
time	$t_{pHL}$	_	3.0 ± 0.3	50	_	5.3	7.5	1.0	8.5	
Input capacitance	C <sub>IN</sub>	_			_	4	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub>			(Note)	_	14	_			pF

Note:

 $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/4 \text{ (per gate)}$ 

### Noise Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

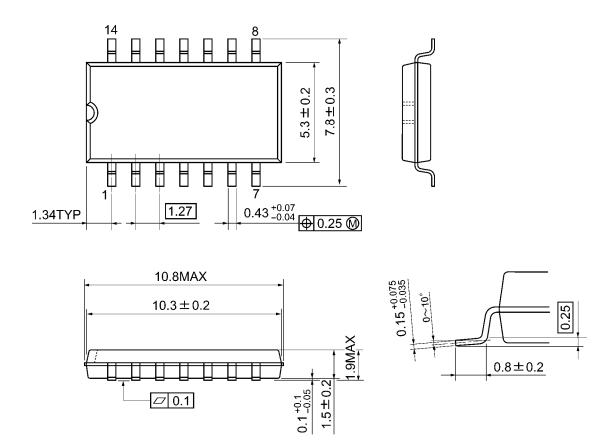
Characteristics	Cumbal	Test Condition	Ta =	- Unit		
	Symbol		V <sub>CC</sub> (V)	Тур.	Limit	Offic
Quiet output maximum dynamic $V_{\mbox{OL}}$	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	0.4	0.8	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-0.4	-0.8	٧
Minimum high level dynamic input voltage	$V_{IHD}$	C <sub>L</sub> = 50 pF	5.0	_	2.0	٧
Maximum low level dynamic input voltage	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	_	0.8	V

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# **Package Dimensions**

SOP14-P-300-1.27A Unit: mm

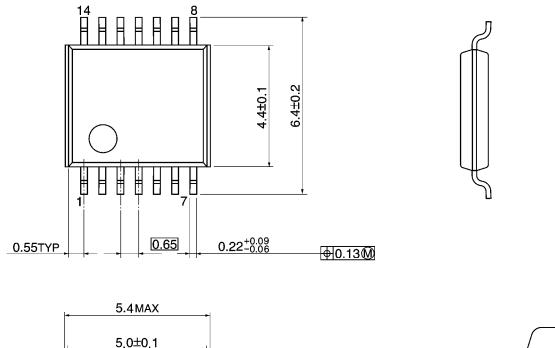


Weight: 0.18 g (typ.)

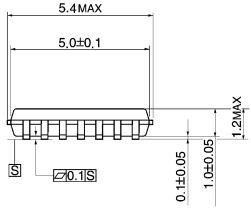
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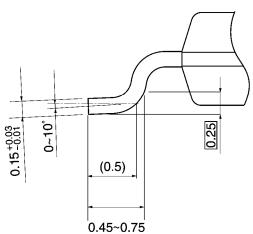
TSSOP14-P-0044-0.65A

Unit: mm



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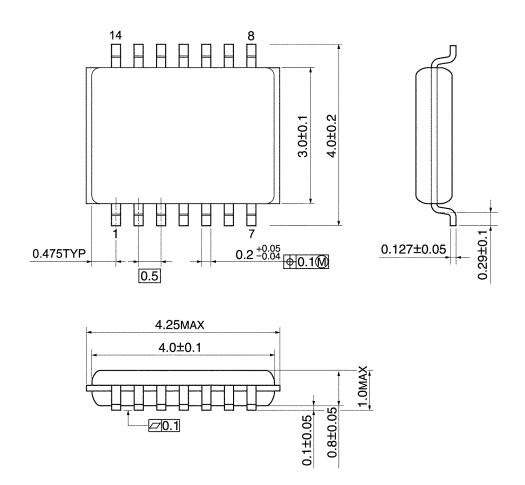




Weight: 0.06 g (typ.)

# **Package Dimensions**

VSSOP14-P-0030-0.50 Unit: mm



Weight: 0.02 g (typ.)

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